

# 2SC1518

### Silicon NPN epitaxial planar type

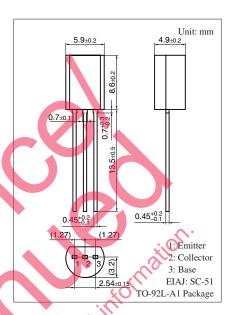
For high-frequency bias oscillation of tape recorders For DC-DC converter

#### ■ Features

- Low collector-emitter saturation voltage V<sub>CE(sat)</sub>
- Satisfactory operation performances and high efficiency with a lowvoltage power supply

### ■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit						
Collector-base voltage (Emitter open)	V <sub>CBO</sub>	25	V	0.45±0.2					
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	20	V	(1.27) (1.27					
Emitter-base voltage (Collector open)	$V_{EBO}$	5	V						
Collector current	$I_C$	1	A	1 2 3 (3)					
Peak collector current	$I_{CP}$	1.5	A	2.54					
Collector power dissipation	Pc	1	W	11:					
Junction temperature	T <sub>j</sub>	150	°C	Si					
Storage temperature	T <sub>stg</sub>	-55 to +150	°C	, Sie of					
Storage temperature $T_{stg} = 55 \text{ to } +150 \text{ °C}$ Electrical Characteristics $T_a = 25 \text{ °C} \pm 3 \text{ °C}$									



### ■ Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-base voltage (Emitter open)	$V_{CBO}$	$I_{\rm C} = 10  \mu A, I_{\rm E} = 0$	25			V
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	$I_C = 1 \text{ mA}$ $I_B = 0$	20			V
Emitter-base voltage (Collector open)	$V_{EBO}$	$I_E = 10 \mu \lambda, I_C \neq 0$	5			V
Collector-base cutoff current (Emitter open)	$I_{CBO}$	$V_{CB} = 25 \text{ V}, I_{P} = 0$			100	nA
Collector-emitter cutoff current (Base open)	I <sub>CEO</sub>	$V_{CE} = 20 V, I_B = 0$			1	μΑ
Forward current transfer ratio	h <sub>FE1</sub> *	$V_{CE} = 2 \text{ V}, I_{C} = 500 \text{ mA}$	90		330	_
	ch <sub>FE2</sub>	$V_{CE} = 2 \text{ V}, I_{C} = 1 \text{ A}$	50	100		_
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	$I_C = 1 \text{ A}, I_B = 50 \text{ mA}$			0.5	V
Base-emitter saturation voltage	V <sub>BE(sat)</sub>	$I_C = 500 \text{ mA}, I_B = 50 \text{ mA}$			1.2	V
Transition frequency	$f_T$	$V_{CB} = 10 \text{ V}, I_E = -50 \text{ mA}, f = 200 \text{ MHz}$		150		MHz
Collector output capacitance	C <sub>ob</sub>	$V_{CB} = 10 \text{ V}, I_{E} = 0, f = 1 \text{ MHz}$		12	20	pF
(Common base, input open circuited)						

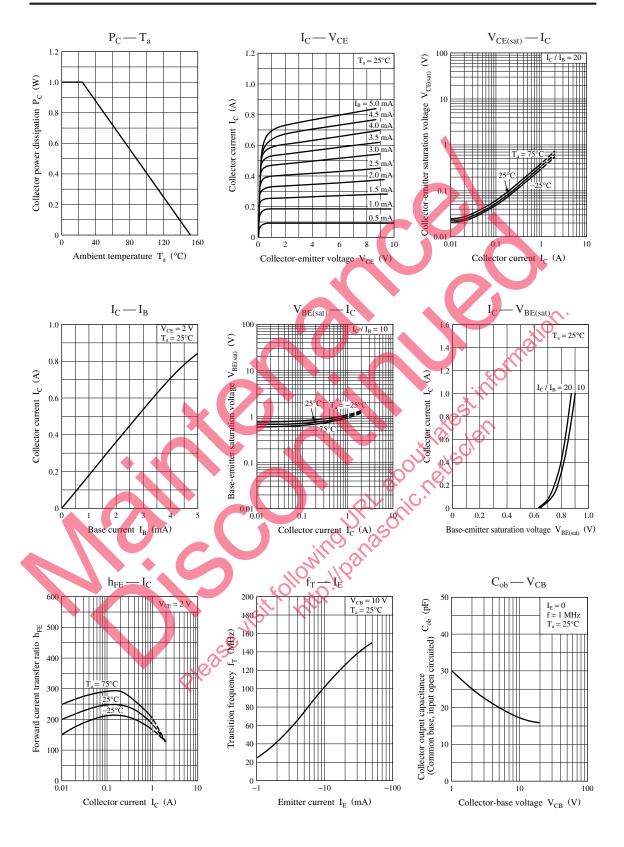
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

#### 2. \*: Rank classification

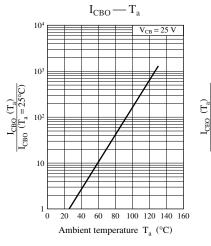
Rank	Q	R	S	
h <sub>FE1</sub>	90 to 155	130 to 220	185 to 330	

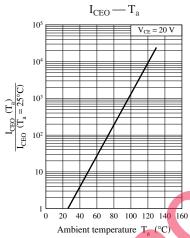
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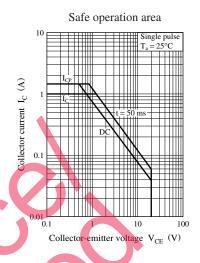
## **Panasonic**



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